

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test | | User Part Number BZX585-C47 Part Description | | | | | | | | | | |
|--|--|---|-----------------------------------|-----------|------------|-----------|--|---------------------|--|--|--|--|
| | | | | | | | | Nexperia DHAM Zener | | | | |
| | | | | | | | | SMD package | | | | |
| | | Test Conditions | Duration | # Lots | # Quantity | # Rejects | | | | | | |
| | | | TEST | | | | | | | | | |
| | | | Pre- and Post-Stress | | | | | | | | | |
| # E1 | Electrical Test | Tamb = 25 °C | N/A | see below | all parts | see below | | | | | | |
| # A1 | PC Preconditioning | JESD22-A113 Bake Tamb = 125 °C Soak Tamb = 85 °C, RH = 85% Reflow soldering | 24 hours 168 hours 3 cycles | 810 | 58300 | 0 | | | | | | |
| # B1 | HTRB High Temperature Reverse Bias | MIL-STD-750-1 M1038 Method A Tj = Tjmax, Vr = 100% of max. datasheet reverse voltage | 1000 hours | 138 | 11040 | 0 | | | | | | |
| # B1b | SSOP Steady State Operational | MIL-STD-750-1 M1038 Method B Tj = Tjmax, Iz = 100% of max. datasheet reverse current | 1000 hours | 20 | 1600 | 0 | | | | | | |
| # A4 | TC Temperature Cycling | JESD22-A104 -65 °C to Tjmax, not to exceed 150°C | 1000 cycles | 170 | 13600 | 0 | | | | | | |
| # A3 alt | AC Autoclave | JESD22-A102 Tamb = 121 °C, RH = 100 % Pressure = 205 kPa (29.7 psia) | 96 hours | 170 | 13600 | 0 | | | | | | |
| # A2 alt | H3TRB High Humidity High Temperature Reverse Bias | JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of rated reverse voltage $^{[1]}$ | 1000 hours | 170 | 13600 | 0 | | | | | | |
| # A5 | IOL Intermittent Operating Life | MIL-STD-750 Method 1037 ton = toff, devices powered to insure $\Delta Tj = 100$ °C for 15000 cycles | 1000 hours | 170 | 13600 | 0 | | | | | | |
| # C8 | RSH Resistance to Solder Heat | JESD22-A111 260 °C ± 5 °C | 10 s | 130 | 3900 | 0 | | | | | | |
| # C10 | SD Solderability | J-STD-002 | | 363 | 3630 | 0 | | | | | | |

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1)
Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|-----------|------------|----------|---------|--------------------|------------|
| Nexperia | | | | | |
| DHAM | Zener | 11040 | 0 | 0.38 | 2.60E+09 |

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